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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Priority Application Serial No. .... 09/989,960  
Priority Filing Date .... November 21, 2001  
Inventor ..... Rickie C. Lake  
Assignee ..... Micron Technology, Inc.  
Priority Group Art Unit ..... 1733  
Priority Examiner ..... J. Haran  
Attorney's Docket No. .... MI40-371  
Title: Thin Profile Battery Bonding Method, Method of Conductively  
Interconnecting Electronic Components, Battery Powerable Apparatus, Radio  
Frequency Communication Device, and Electric Circuit

**PRELIMINARY AMENDMENT**

To: Mail Stop Patent Application  
Commissioner for Patents  
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Sir:

This is a preliminary amendment accompanying a Request for Continuation Application for the above-entitled patent application. Prior to examining the application, please enter the following amendments.

**AMENDMENTS**

Underlines indicate insertions and ~~strikeouts~~ indicate deletions.